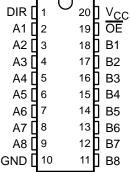
SCLS487A - MAY 2003 - REVISED JUNE 2003

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree[†]
- Operating Range 2-V to 5.5-V V_{CC}
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 1000 V Per MIL-STD-833, Method 3015; Exceeds 100 V Using Machine Model (C = 200 pF, R = 0)

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DW OR PW PACKAGE (TOP VIEW)



description/ordering information

The SN74AHC245 octal bus transceiver is designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

This device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses effectively are isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PAC	(AGE [‡]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	SOIC - DW	Tape and reel	SN74AHC245MDWREP	AHC245MEP
-55 C to 125 C	TSSOP – PW	Tape and reel	SN74AHC245MPWREP	AHC245EP

[‡] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



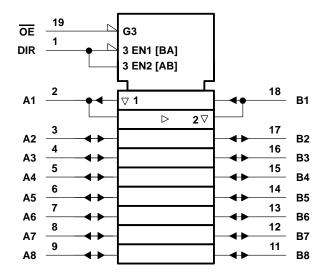
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



FUNCTION TABLE (each transceiver)

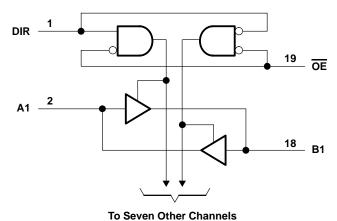
INP	UTS	ODEDATION					
OE	DIR	OPERATION					
L	L	B data to A bus					
L	Н	A data to B bus					
Н	X	Isolation					

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





SCLS487A - MAY 2003 - REVISED JUNE 2003

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1): Control inputs	0.5 V to 7 V
I/O, output voltage range, V _O (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0): Control inputs	–20 mA
I/O, output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V _{CC} or GND	±75 mA
Package thermal impedance, θ_{JA} (see Note 2): DW package	58°C/W
PW package	83°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	V
		V _{CC} = 2 V	1.5		
V_{IH}	High-level input voltage	V _{CC} = 3 V	2.1		V
	VIH High-level input voltage VIL Low-level input voltage VI Input voltage VO Output voltage IOH High-level output current	$V_{CC} = 5.5 V$	3.85		
		V _{CC} = 2 V		0.5	
V_{IL}	Low-level input voltage V _{CC} = 3 V			0.9	V
		$V_{CC} = 5.5 \text{ V}$		1.65	
٧ _I	Input voltage	OE or DIR	0	5.5	V
۷o	Output voltage	A or B	0	VCC	V
		V _{CC} = 2 V		-50	μΑ
ІОН	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	mA
		V_{CC} = 5 V \pm 0.5 V		-8	ША
		V _{CC} = 2 V		50	μΑ
loL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4	mA
		V_{CC} = 5 V \pm 0.5 V		8	ША
A+/A>.	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100	ns/V
Δt/Δv	input transition rise of fail rate	$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$		20	115/ V
TA	Operating free-air temperature		-55	125	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

SN74AHC245-EP OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCLS487A - MAY 2003 - REVISED JUNE 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	Vac	T	չ = 25°C	;	MIN	MAX	UNIT
	PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	IVIIIV	WAA	UNIT
			2 V	1.9	2		1.9		
		I _{OH} = -50 μA	3 V	2.9	3		2.9		
Vон			4.5 V	4.4	4.5		4.4		V
		I _{OH} = -4 mA	3 V	2.58			2.48		
		I _{OH} = -8 mA	4.5 V	3.94			3.8		
			2 V			0.1		0.1	
		I _{OL} = 50 μA	3 V			0.1		0.1	V
VOL			4.5 V			0.1		0.1	
		I _{OL} = 4 mA	3 V			0.36		0.5	
		I _{OL} = 8 mA	4.5 V			0.36		0.5	
1.	A or B inputs	V. – F.F.V. or CND	5.5 V			±0.1		±1	
1 ₁	OE or DIR	V _I = 5.5 V or GND	0 V to 5.5 V			±0.1		±1	μΑ
l _{OZ} †		$V_O = V_{CC}$ or GND, $V_I (\overline{OE}) = V_{IL}$ or V_{IH}	5.5 V			±0.25		±2.5	μΑ
ICC		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40	μΑ
Ci	OE or DIR	$V_I = V_{CC}$ or GND	5 V		2.5	10			pF
C _{io}	A or B inputs	V _I = V _{CC} or GND	5 V		4				pF

[†] The parameter IOZ includes the input leakage current.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	TΔ	= 25°C	;	MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIV	IVIAA	UNIT
^t PLH	A or B	B or A	C _I = 15 pF		5.8	8.4	1	10	nc
^t PHL	AUIB	B or A	CL = 15 pr		5.8	8.4	1	10	ns
^t PZH	ŌĒ	A or B	C: - 15 pF		8.5	13.2	1	15.5	20
^t PZL	OE	Aorb	C _L = 15 pF		8.5	13.2	1	15.5	ns
^t PHZ	ŌĒ	A or B	C _L = 15 pF		8.9	12.5	1	15.5	ns
^t PLZ	OE				8.9	12.5	1	15.5	115
^t PLH	A or B	B or A	C _L = 50 pF		8.3	11.9	1	13.5	nc
^t PHL	AUIB				8.3	11.9	1	13.5	ns
^t PZH	ŌĒ	A or B	C: - 50 pF		11	16.7	1	19	ns
^t PZL	OE	AUID	C _L = 50 pF		11	16.7	1	19	118
^t PHZ	ŌĒ	A or B	0 50 5		11.5	15.8	1	18	no
t _{PLZ}	OE .	AUID	C _L = 50 pF		11.5	15.8	1	18	ns



SCLS487A - MAY 2003 - REVISED JUNE 2003

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	λ = 25°C	;	MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIV	WAX	ONII
^t PLH	A or B	B or A	C _I = 15 pF		4	5.5	1	6.5	ns
^t PHL	AOIB	BUIA	C[= 13 μ		4	5.5	1	6.5	110
^t PZH	ŌĒ	A or B	C _L = 15 pF		5.8	8.5	1	10	ns
^t PZL	OE	A or B	CL = 15 pr		5.8	8.5	1	10	110
^t PHZ	ŌĒ	A or B	C _L = 15 pF		5.6	7.8	1	9.2	ns
t _{PLZ}	OE				5.6	7.8	1	9.2	113
^t PLH	A or B	B or A	C: 50 pF		5.5	7.5	1	8.5	ns
^t PHL	AOIB	BUIA	$C_L = 50 \text{ pF}$		5.5	7.5	1	8.5	115
^t PZH	ŌĒ	A or B	C _L = 50 pF		7.3	10.6	1	12	ns
^t PZL	OE .	AUID	CL = 50 pr		7.3	10.6	1	12	115
^t PHZ	ŌĒ	A or B	C: - 50 pF		7	9.7	1	11	200
^t PLZ	OE	AUID	C _L = 50 pF		7	9.7	1	11	ns

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

	PARAMETER	MIN	TYP	MAX	UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.9		V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.9		V
V _{OH(V)}	Quiet output, minimum dynamic V _{OH}		4.3		V
VIH(D)	High-level dynamic input voltage	3.5			V
V _{IL(D)}	Low-level dynamic input voltage			1.5	V

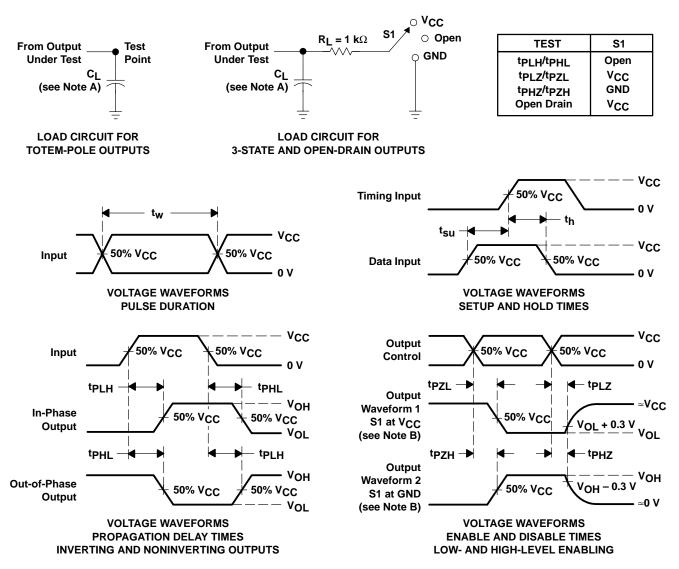
NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load, f = 1 MHz	14	pF



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN74AHC245MDWREP	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC245MEP
SN74AHC245MDWREP.A	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC245MEP
SN74AHC245MPWREP	Active	Production	TSSOP (PW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC245EP
SN74AHC245MPWREP.A	Active	Production	TSSOP (PW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC245EP
V62/03650-01XE	Active	Production	TSSOP (PW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC245EP
V62/03650-01YE	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC245MEP

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.





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OTHER QUALIFIED VERSIONS OF SN74AHC245-EP:

● Catalog : SN74AHC245

• Automotive : SN74AHC245-Q1

• Military : SN54AHC245

NOTE: Qualified Version Definitions:

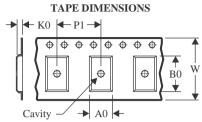
- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

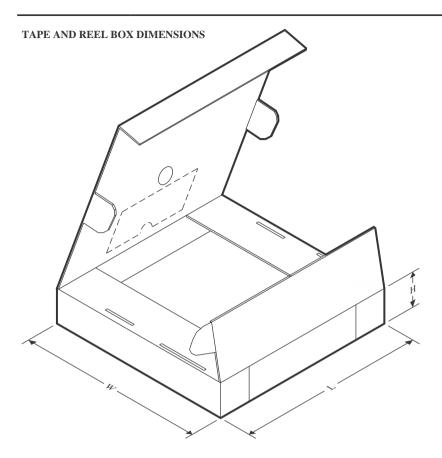
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AHC245MDWREP	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74AHC245MPWREP	TSSOP	PW	20	2000	330.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1

www.ti.com 24-Jul-2025



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AHC245MDWREP	SOIC	DW	20	2000	356.0	356.0	45.0
SN74AHC245MPWREP	TSSOP	PW	20	2000	353.0	353.0	32.0

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